# NOTES (UNLESS OTHERWISE SPECIFIED):

### **GENERAL**

- 1) PCB IS 6-LAYER, .062" THICK,

- 1) Fice is deficient and thinks.

  2) Construction is Solder-Mask-Over-Bare-Copper (smode).

  3) ACCEPTABLITY SHALL BE BASED ON PC-A-BOD, CLASS 2.

  4) THE FOLLOWING GERBER RS27X PHOTO TOOL FLES SHALL BE USED TO DEFINE ALL CROUT FEATURES. \*.GTL - TOP LAYER GERBER DATA
  - \*.G1 MID LAYER 1 GERBER DATA
  - \*.GP1- INTERNAL PLANE LAYER 1 GERBER DATA
  - \*.GP2 INTERNAL PLANE LAYER 2 GERBER DATA
  - \*.GP3- INTERNAL PLANE LAYER 3 GERBER DATA
  - \*.GBL BOTTOM LAYER GERBER DATA
  - \*GBO BOTTOM OVERLAY GERBER DATA
  - \*.GBP BOTTOM-SIDE SOLDER PASTE MASK
  - \*.GBS BOTTOM SOLDER MASK GERBER DATA
  - \*.GTO TOP OVERLAY GERBER DATA
  - \*.GTP TOP-SIDE SOLDER PASTE MASK
  - \*.GTS TOP SOLDER MASK GERBER DATA
- THE PHOTO TOOL SHALL NOT BE COMPENSATED WITHOUT PRIOR ENGINEERING APPROVAL PCB DESIGNER: RICH LOBDIL. PH (805) 880-1621 FAX (805) 961-1792.

### FABRICATION TOLERANCES

- 6) END PRODUCT CONDUCTOR WIDTHS AND PAD DIAMETERS SHALL NOT VARY MORE THAN 0.002" FROM THE 1:1 DIMENSIONS OF THE MASTER ARTWORK.
- 7) THE CONDUCTIVE PATTERN SHALL BE POSITIONED SO THAT THE LOCATION OF ANY PAD OR
- LAND SHALL BE WITHIN 0.005" DIAMETER TO THE TRUE POSITION OF THE HOLE IT CIRCUMSCRIBES.
- 8) ALL DRILL HOLE SIZES AND TOLERANCES APPLY AFTER PLATING.
- 9) THE MINIMUM ANNULAR RING SHALL BE 0.005".
  10) BOW AND TWIST SHALL NOT EXCEED 0.010" PER INCH.
- 11) FOR PCB ROUTING DIMENSIONS: .XXX = +/-.005" .XX = +/-.020"

### MATERIAL

- 12) BASE MATERIAL IS FR4 EPOXY FIBERGLASS
  13) SEE STACK-UP LEGEND FOR COPPER CLADDING CALL OUTS

## PLATING

- 14) ALL HOLES AND CONDUCTIVE SURFACES SHALL BE PLATED WITH A MINIMUM OF 0.001" COPPER.
- AFTER SOLDERMASK, ALL EXPOSED HOLES AND CONDUCTIVE SURFACES SHALL BE COATED WITH A GOLD IMMERSION PLATING TO PRESERVE SOLDERABILITY.

# COATINGS

- 16) THE SOLDERMASK SHALL BE BLACK LIQUID PHOTO-MAGEABLE PER IPC-SM-840, TYPE-B, CLASS 2.
- 17) THE SOLDERMASK REGISTRATION ALLOWANCE IS 0.003". THERE SHALL BE NO SOLDERMASK ON ANY SOLDER PAD OR LAND.

# MARKING

- 18) THE LEGEND SHALL BE SCREEN-PRINTED USING PERMANENT YELLOW EPOXY INK.
- 19) THE SCREEN PRINTING REGISTRATION ALLOWANCE IS 0.007". THERE SHALL BE NO INK ON ANY SOLDER PAD OR LAND
- 20) THE VENDOR CODE AND UL FLAMMABILITY RATING MAY BE ETCHED IN THE FOL OR MARKED IN PERMANENT EPOXY INK (VENDOR'S OPTION).

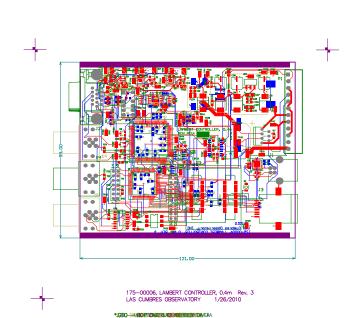
## ELECTRICAL TESTING

21) ALL BOARDS SHALL BE ELECTRICALLY TESTED TO THE SUPPLED PC-D-356A NET LIST FOR CONTINUITY, OPENS AND SHORTS.

Layer Stack Up Detail fo	or: 175-00006_rev_3.PcbDoc
Layer Name	
Top Layer (*.GTL)	1/2 oz (1 oz. finished)
Mid-Layer 1 (*.G1)	1/2 oz
VCC (*.GP1)	1/2 oz
GND (*.GP2)	1/2 oz
+24V (*.GP3)	1/2 oz
Bottom Layer (*.GBL)	1/2 oz (1 oz. finished)
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NOTICE

THIS DRAWING EMBODES A PROPRETARY DESGN OWNED BY LAS CUMBERS OBSERVATORY, IT IS SUBMITTED FOR A SPECFIC PURPOSE UNDER A CON-PIDENTIAL RELATION-SHE, AND EXCEPT FOR PURPOSES DYPRESSLY CRANITED IN MISTRICA, LIR GRITS ARE RESERVED BY LAS CUMBERS OBSERVATORY.



PRIMARY PCB SPECIFICATIONS (REFER TO COMPLETE SPEC LISTING AT LEFT FOR FURTHER DETAILS) NUMBER OF LAYERS -6 FINISHED THICKNESS .062"

BASE MATERIAL FR4 GOLD IMMERSION PLATING TYPE SOLDER MASK COLOR -**BLACK** 

Las Cumbres Observatory, Inc. Las Cumbres Observator 6740 Cortona Dr. Goleta, CA 93117 www.lcogt.net 6/14/2010 Rich Lobell Dich Lobelli 175-00006, Lambert Controller, 0.4m - GPT ″3 <sup>™</sup>″1 ∘ ∈ X